18/May/2007

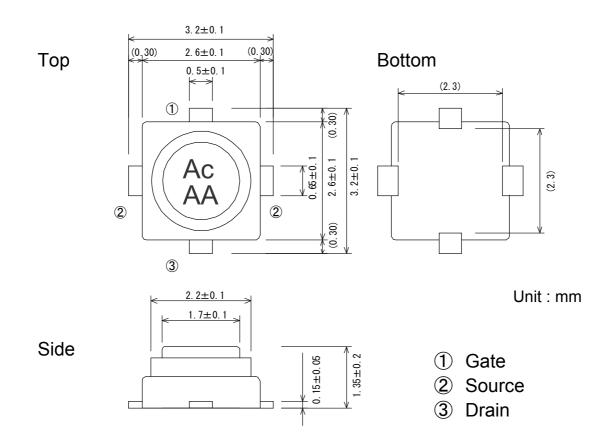
SUPER LOW NOISE InGaAs HEMT

DESCRIPTION The MGF4941AL super-low noise HEMT (High Electron Mobility Transistor) is designed for use in Ku band amplifiers.				Itline Drawing		
High associate	= 0.35dB (Typ.)		Fig.1			
APPLICATIC	DN w noise amplifiers					
QUALITY GR GG	ADE			GD-32		
RECOMMEN V _{DS} =2V , I _D =1	DED BIAS CONDITIONS ^{0mA}	MITSUBIS Not to be rep without perm	oroduced o			
Tape & reel	INFORMATION 4000pcs./reel			Keep Safety first in your circuit designs! Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them.		
r		a=25°C)	11.26	Trouble with semiconductors may lead to personal		
Symbol V _{GDO}	Parameter	Ratings	Unit V	injury , fire or property damage. Remember to give due consideration to safety when making your		
VGDO	Gate to drain voltage	-4	V	circuit designs, with appropriate measure such		
VGSO ID	Gate to source voltage Drain current	IDSS	v mA	as (I) placement of substitutive , auxiliary circuits , (ii) use of non-flammable material or (iii) prevention		
				against any malfunction or mishap.		
T _{ch}	Channel temperature	mW °C				
T _{ch} T _{stg}	Channel temperature Storage temperature	125 -55 to +125	⊃° ⊃°			

ELECTRICAL CHARACTERISTICS

ELECTRI	CAL CHARACTERISTICS	(Ta=25°C)				
Synbol	Parameter	Test conditions	Limits			Unit
			MIN.	TYP.	MAX	
V _{(BR)GDO}	Gate to drain breakdown voltage	I _G =-10μA	-3			V
I _{GSS}	Gate to source leakage current	V _{GS} =-2V,V _{DS} =0V		-	50	μA
I _{DSS}	Saturated drain current	V _{GS} =0V,V _{DS} =2V	15		60	mA
V _{GS(off)}	Gate to source cut-off voltage	V _{DS} =2V,I _D =500μA	-0.1	-	-1.5	V
Gs	Associated gain	V _{DS} =2V,I _D =10mA	12.0	13.5		dB
NFmin.	Minimum noise figure	f=12GHz		0.35	0.5	dB

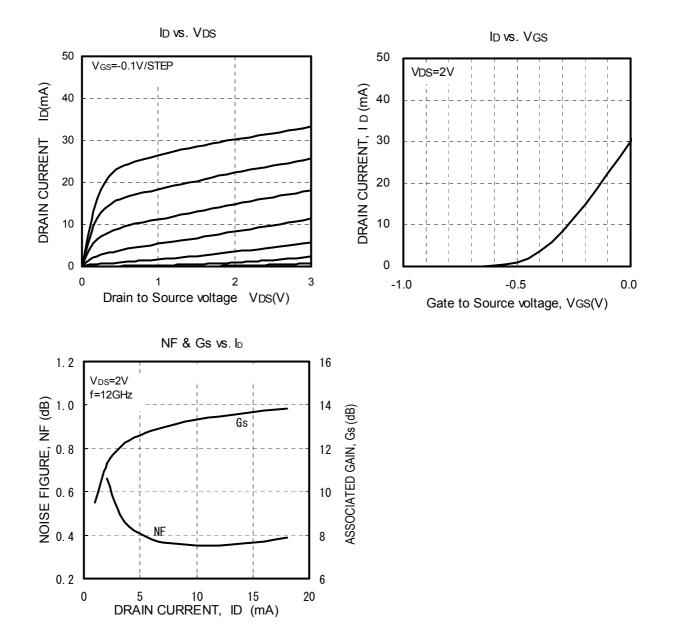
Fig.1



(GD-32)

SUPER LOW NOISE InGaAs HEMT

TYPICAL CHARACTERISTICS (Ta=25°C)



SUPER LOW NOISE InGaAs HEMT

S PARAMETERS

Freq.	S	11	S	S21 S12		S22		
(GHz)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
1	0.989	-13.9	5.497	164.6	0.017	78.9	0.637	-10.6
2	0.967	-28.2	5.416	149.6	0.028	70.9	0.626	-21.1
3	0.929	-41.5	5.278	135.0	0.040	61.7	0.610	-31.1
4	0.882	-54.4	5.172	121.5	0.051	53.3	0.586	-40.5
5	0.822	-65.9	4.932	108.0	0.061	45.9	0.572	-50.8
6	0.757	-79.5	4.959	94.1	0.071	37.6	0.538	-60.3
7	0.686	-93.3	4.826	80.4	0.080	29.9	0.502	-69.8
8	0.611	-108.8	4.732	66.8	0.086	22.7	0.456	-78.6
9	0.533	-125.1	4.587	53.6	0.092	16.2	0.408	-86.5
10	0.463	-143.6	4.403	40.5	0.096	10.2	0.359	-93.8
11	0.411	-164.1	4.140	27.8	0.100	4.8	0.311	-100.7
12	0.382	174.7	4.010	15.6	0.105	0.1	0.267	-108.9
13	0.378	152.3	3.782	3.3	0.111	-4.7	0.221	-119.3
14	0.395	131.4	3.653	-9.1	0.115	-9.7	0.182	-135.4
15	0.435	113.6	3.514	-21.3	0.121	-14.6	0.152	-157.0
16	0.486	99.0	3.366	-32.9	0.126	-19.8	0.134	177.7
17	0.543	86.2	3.172	-45.3	0.133	-25.5	0.139	145.4
18	0.603	73.7	3.049	-57.7	0.140	-31.2	0.183	115.8
19	0.663	61.2	2.877	-70.2	0.147	-37.9	0.251	95.1
20	0.704	50.1	2.641	-81.3	0.152	-45.0	0.309	80.2
21	0.746	40.5	2.470	-91.5	0.156	-52.4	0.363	70.0
22	0.778	32.3	2.311	-102.3	0.156	-58.0	0.411	59.8

(VDS=2V,ID=10mA,Ta=room temperature)

NOISE PARAMETERS (VDS=2V,ID=10mA, Ta=25°C)

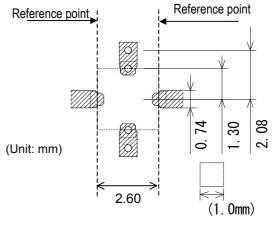
Freq.	Гopt		rn	NFmin
(GHz)	(mag) (ang)			(dB)
2	0.671	13.9	0.370	0.20
4	0.598	37.2	0.262	0.22
6	0.537	60.8	0.197	0.25
8	0.474	86.2	0.155	0.29
10	0.399	119.2	0.102	0.32
12	0.329	147.6	0.062	0.35
14	0.299	173.6	0.069	0.40
16	0.349	-143.9	0.083	0.49
18	0.392	-106.5	0.109	0.59
20	0.432	-73.0	0.146	0.73
22	0.467	-42.7	0.180	0.96

Note: rn is normarised by 50 ohm.

Board: Er=2.2

Thickness: 0.25mm

(4- ϕ 0.3: through-hole)



SUPER LOW NOISE InGaAs HEMT

S PARAMETERS

(VDS=0V,VGS=0V,Ta=room temperature)

Freq.		11	S21		S12		S22	
(GHz)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
1	0.996	-12.6	0.008	90.7	0.008	93.1	0.700	167.0
2	0.998	-25.4	0.019	92.4	0.019	92.2	0.696	154.5
3	0.988	-38.1	0.032	90.0	0.032	90.6	0.703	142.2
4	0.984	-50.8	0.048	86.4	0.048	86.3	0.708	129.1
5	0.971	-62.6	0.068	80.5	0.069	81.0	0.710	117.1
6	0.963	-77.1	0.092	72.6	0.092	72.7	0.718	104.8
7	0.949	-92.8	0.119	62.9	0.120	62.9	0.730	92.6
8	0.936	-110.9	0.149	51.8	0.150	52.2	0.739	81.3
9	0.915	-131.2	0.181	39.2	0.182	39.5	0.750	70.7
10	0.892	-153.9	0.211	25.5	0.211	25.9	0.760	60.8
11	0.878	-178.2	0.235	10.8	0.237	11.1	0.769	51.6
12	0.870	157.5	0.252	-3.9	0.252	-3.9	0.785	42.8
13	0.868	133.9	0.258	-18.6	0.259	-18.6	0.795	34.7
14	0.875	113.0	0.257	-32.0	0.257	-32.0	0.805	26.9
15	0.883	94.9	0.250	-44.4	0.249	-44.1	0.815	19.2
16	0.895	79.7	0.238	-55.0	0.238	-54.9	0.824	11.6
17	0.901	66.6	0.225	-64.2	0.225	-64.0	0.833	5.2
18	0.912	54.7	0.213	-72.0	0.215	-71.8	0.845	0.1
19	0.923	43.8	0.205	-78.8	0.205	-78.7	0.856	-3.7
20	0.934	34.0	0.201	-85.1	0.202	-85.5	0.861	-8.4
21	0.947	25.0	0.195	-92.1	0.193	-92.7	0.859	-13.1
22	0.945	17.6	0.188	-98.3	0.188	-98.5	0.854	-18.2

(VDS=0V,VGS=-2.5V,Ta=room temperature)

Freq.	S	11	S21		S12		S22	
(GHz)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
1	1.003	-8.2	0.022	80.5	0.023	79.5	0.998	-9.2
2	0.998	-16.7	0.045	72.1	0.045	71.9	0.990	-18.6
3	0.994	-24.6	0.067	62.9	0.067	63.2	0.995	-27.7
4	0.991	-32.2	0.088	54.8	0.089	54.7	0.993	-36.7
5	0.986	-38.9	0.109	46.3	0.110	46.5	0.993	-46.8
6	0.983	-46.7	0.133	37.4	0.132	37.5	0.985	-56.3
7	0.977	-54.4	0.157	28.6	0.158	28.7	0.982	-65.6
8	0.972	-63.3	0.183	18.8	0.184	18.6	0.970	-75.4
9	0.963	-72.7	0.211	8.3	0.210	8.5	0.962	-85.2
10	0.950	-83.2	0.237	-2.6	0.238	-2.7	0.956	-95.5
11	0.938	-94.7	0.263	-14.9	0.264	-14.8	0.945	-106.4
12	0.929	-107.7	0.289	-27.8	0.289	-27.8	0.932	-118.6
13	0.916	-121.9	0.310	-42.3	0.312	-42.2	0.921	-132.8
14	0.911	-137.5	0.326	-58.6	0.327	-58.7	0.914	-149.6
15	0.904	-155.7	0.324	-76.7	0.325	-76.6	0.909	-167.8
16	0.903	-175.3	0.305	-95.2	0.306	-95.4	0.911	173.5
17	0.910	163.6	0.269	-114.1	0.271	-114.4	0.916	153.5
18	0.914	142.1	0.219	-131.5	0.220	-131.6	0.924	133.0
19	0.912	121.4	0.172	-145.0	0.172	-144.9	0.926	114.9
20	0.927	103.4	0.136	-160.1	0.136	-160.2	0.939	99.3
21	0.955	87.0	0.089	-178.2	0.090	-176.6	0.961	84.2
22	0.971	72.1	0.048	167.9	0.049	171.4	0.968	69.8

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